

DOCKET NO: 295408US40PCT

**IN THE UNITED STATES PATENT & TRADEMARK OFFICE**

IN RE APPLICATION OF :  
DAISUKE HIROKANE : EXAMINER: FEELY, MICHAEL J  
SERIAL NO: 10/594,322 :  
FILED: JANUARY 17, 2007 : GROUP ART UNIT: 1796  
FOR: EPOXY RESIN COMPOSITION :  
FOR THE ENCAPSULATION OF  
SEMICONDUCTORS AND  
SEMICONDUCTOR DEVICES

**AMENDMENT AFTER FINAL**

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Office Action dated November 3, 2009, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 4 of this paper.